









# PRODUCT DATASHEET



- ► PLCC2
- ➤ 3020 Series
- ► Cool White (5700K)

N0W02S31





# 3020 Series





#### **FEATURES:**

Package: PLCC White SMT Package

Forward Current: 60mA Forward Voltage (typ.): 3.2V

**Materials:** 

Resin: Silicon (Yellow Diffused) Operating Temperature: -20~+80°C

Storage Temperature: -30~+100°C

**Grouping parameters:** 

Forward voltage

Luminous flux

**CIE Chromaticity** 

Soldering methods: IR Reflow soldering; wave soldering

Preconditioning: acc. to JEDEC Level 3

Packing: 8mm tape with 2000/reel, ø180mm (7")

## **APPLICATIONS:**

- LCD Backlighting
- **General Lighting**
- **Commercial Lighting**
- **Residential Lighting Architectural Lighting**
- Flash Lighting

Release Date: 19 December 2013 Version: A1.1

Luminous Flux (typ.): 22lm @60mA Colour: Cool White **CCT:** 5700K Viewing angle: 120°

Die: InGaN



## **CHARACTERISTICS:**

# Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	60	mA
Peak Forward Current Duty 1/10@10KHz	I <sub>FP</sub>	100	mA
Reverse Current @5V	I <sub>R</sub>	50	μΑ
Power Dissipation	PD	0.2	W
Electrostatic Discharge	ESD	500	V
Operating Temperature	T <sub>OPR</sub>	-20~+80	°C
Storage Temperature	T <sub>STG</sub>	-30~+100	°C
Colour Rendering Index	CRI	>80	

# Electrical & Optical Characteristics (Ta=25°C)

Parameter	Cumbal	Values			Unit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	$V_{F}$	2.8		3.6	V	I <sub>F</sub> =60mA	
Luminous Flux	Фу	18	22		lm	I <sub>F</sub> =60mA	
Chromaticity Coordinates	Х	0.321		0.338		I <sub>F</sub> =60mA	
	Y	0.324		0.362			
Colour Temperature	ССТ	5310	5700	6020	К	I <sub>F</sub> =60mA	
Viewing Angle	2θ <sub>1/2</sub>		120		deg	I <sub>F</sub> =60mA	

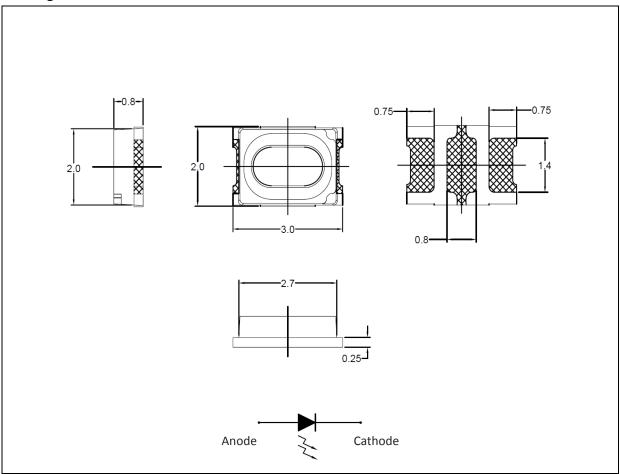
<sup>1.</sup> Luminous intensity (I<sub>V</sub>)  $\pm 15\%$ , Forward Voltage (V<sub>F</sub>)  $\pm 0.1V$ , Viewing angle( $2\theta_{1/2}$ )  $\pm 5\%$ , CRI  $\pm 3$ 

<sup>2.</sup> IS standard testing



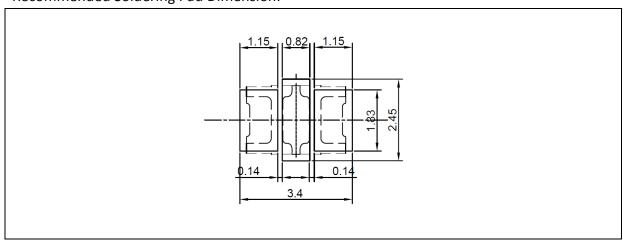
## **OUTLINE DIMENSION:**

# Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

# **Recommended Soldering Pad Dimension:**



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



# **BINNING GROUPS:**

# Forward Voltage Classifications ( $I_F = 60 \text{mA}$ ):

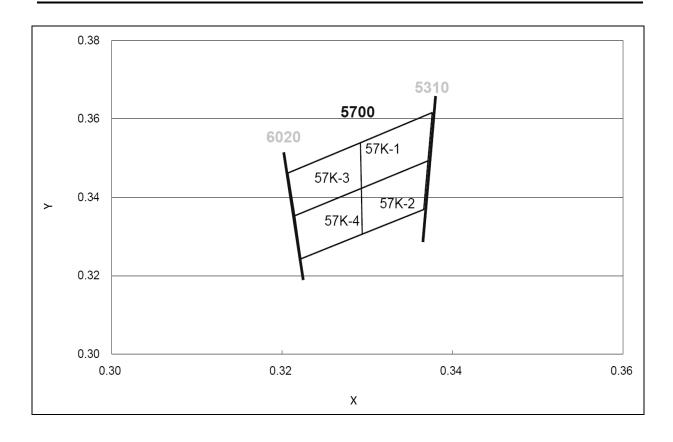
Code	Min.	Max.	Unit
1	2.8	2.9	
2	2.9	3.0	
3	3.0	3.1	
4	3.1	3.2	V
5	3.2	3.3	V
6	3.3	3.4	
7	3.4	3.5	
8	3.5	3.6	

# Luminous Flux Classifications ( $I_F = 60$ mA):

Code	Min.	Max.	Unit	
F18D	18	20		
F20D	20	22		
F22D	22	24	lm	
F24D	24	26	"""	
F26D	26	28		
F28D	28	30		



# **CIE CHROMATICITY DIAGRAM:**

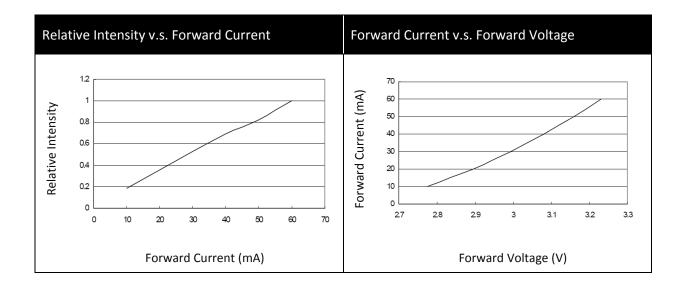


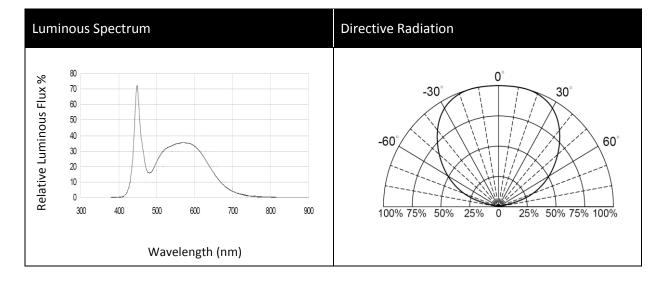
# Chromaticity Coordinates Classifications (I<sub>F</sub> = 60mA):

	-	l	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	X	Υ
57K-1	0.3376	0.3616	0.3292	0.3539	0.3293	0.3423	0.3371	0.3493
57K-2	0.3371	0.3493	0.3293	0.3423	0.3294	0.3306	0.3366	0.3369
57K-3	0.3292	0.3539	0.3207	0.3462	0.3215	0.3353	0.3293	0.3423
57K-4	0.3293	0.3423	0.3215	0.3353	0.3222	0.3243	0.3294	0.3306



## **ELECTRO-OPTICAL CHARACTERISTICS:**

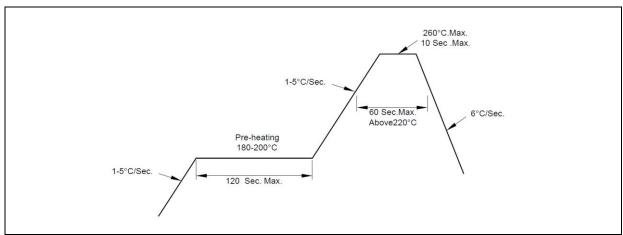




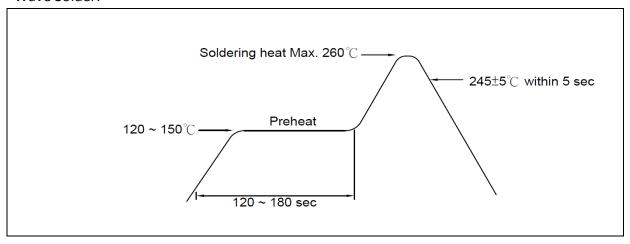


## **RECOMMENDED SOLDERING PROFILE:**

#### Lead-free Solder:



### Wave Solder:



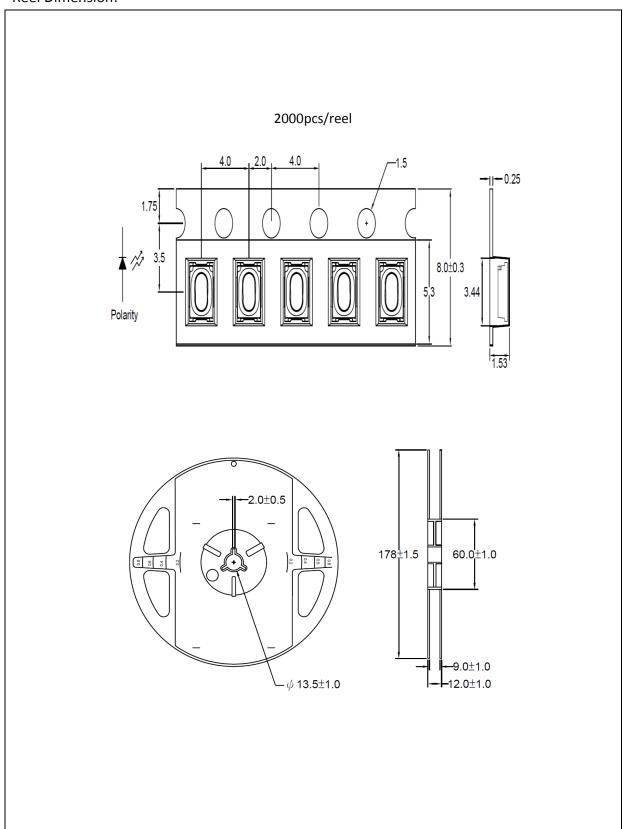
#### Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



# **PACKING SPECIFICATION:**

### Reel Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

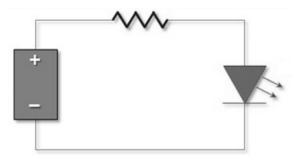
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.</li>
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

## **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

## Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.